

ATTACHMENT 1(g)

LIST OF ADDITIONAL SUBMITTED DOCUMENTS	ATTORNEY DOCKET NO.	APPLICATION NO.
	1506.1011	09/964,637
	FIRST NAMED INVENTOR	
	Tsuneyuki TSUJI, et al.	
	FILING DATE	GROUP ART UNIT
	September 28, 2001	2145

The following document(s) is/are listed in accordance with the duty of disclosure provisions of 37 CFR § 1.56, so that the Examiner may consider same should he deem any thereof to be material to examination of the subject application.

It is requested that the Examiner acknowledge his consideration of document(s) below-listed by initialling same in the space provided adjacent each such application and that the Examiner sign and date this form at the bottom thereof to confirm such consideration having been given.

This submission in no way represents an admission that any of the information listed herein constitutes prior art with respect to the subject application; and unless and until such prior art status is established, this submission is not a request that the information presented herein be printed on the face of any patent issuing from the subject application in which this information is being filed.

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NO.	DATE	NAME	CLASS	SUB-CLASS	FILING DATE
	BA						
	BB						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATION YES NO
	BC						

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)			TRANSLATION YES NO
BD	Japanese Office Action mailed December 5, 2006 in corresponding Japanese Application No. 2001-160019 (3 pages) (5 pages English translation)		X
BE	Japanese Office Action mailed March 6, 2007 in corresponding Japanese Application No. 2001-160019 (3 pages) (5 pages English translation)		X

EXAMINER /Patrice Winder/	DATE CONSIDERED	8/13/2010
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*EXAMINER: Initial if document considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.